509073685 03/12/2025

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HYCON TECHNOLOGY CORPORATION	03/06/2025

RECEIVING PARTY DATA

Company Name:	Silicon Integrated Systems Corp.	
Street Address:	NO.180, SEC. 2, GONGDAO 5TH RD., EAST DIST.	
City:	HSINCHU CITY	
State/Country:	CHINA	
Postal Code:	30070	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12232353

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	Mr. Alon Zelouf
SIGNATURE:	/Mr. Alon Zelouf/
DATE SIGNED: 03/12/2025	
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

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PATENT 509073685 REEL: 070477 FRAME: 0759

ASSIGNMENT

ASSIGNOR(S):

HYCON TECHNOLOGY CORPORATION

each ASSIGNOR, as listed above, and also referred to hereinafter as "ASSIGNOR," hereby sells, assigns, and transfers to:

ASSIGNEE(S):

Silicon Integrated Systems Corp.

NO.180, SEC. 2, GONGDAO 5TH RD., EAST DIST., HSINCHU CITY, 30070, TAIWAN, R.O.C.

and the successors, assigns and legal representatives of the ASSIGNEE,

the entire right, title and interest for the United States and its Territorial Possessions and in all foreign countries, including all rights to claim priority,

in and to any and all improvements, which are disclosed in the following inventions:

Patent Application No.: 12/155,035

filed: 2008-5-29

Patent Application No.: 12/232,353

filed: 2008-9-16

Patent Application No.: 12/081,326

filed: 2008-4-15

Patent Application No.: 13/550,724

filed: 2012-7-17

Patent Application No.: 13/589,213

filed: 2012-8-20

Patent Application No.: 14/170,797

filed: 2014-2-3

Patent Application No.: 14/186,067

filed: 2014-2-21

Patent Application No.: 15/044,505

filed: 2016-2-16

Patent Application No.: 14/196,015

filed: 2014-3-4

Patent Application No.: 14/589,401

filed: 2015-1-5

Patent Application No.: 15/214,504

filed: 2016-7-20

Patent Application No.: 16/249,138

filed: 2019-1-16

Patent Application No.: 16/357,427

filed: 2019-3-19

Patent Application No.: 16/460,516

filed: 2019-7-2

Patent Application No.: 16/711,526

filed: 2019-12-12

Patent Application No.: 16/835,401

filed: 2020-3-31

Patent Application No.: 16/895,385

filed: 2020-6-8

Patent Application No.: 17/512,849

filed: 2021-10-28

Patent Application No.: 17/172,136

filed: 2021-2-10

Patent Application No.: 17/854,097

filed: 2022-6-30

and any legal equivalents thereof in a foreign country, including the right to claim priority; and,

in and to, all Letters Patent to be obtained for said invention by the above-referenced patent application or any provisional, non-provisional, refiling, continuation, continuation-in-part, division, renewal, or substitute thereof, related to, or claiming priority from, and as to any Letters Patent, any reissue or reexamination thereof.

ASSIGNOR hereby covenants that no other assignment, sale, agreement or encumbrance has been or will be made or entered into with regard to the above-referenced patent application or its underlying disclosures or resulting patent(s) and no assignments will be made or entered into which would conflict with this Assignment.

ASSIGNOR further assigns all rights to the ASSIGNEE to bring suit for infringement or other cause of action arising out of or relating to the above-referenced patent application and its resulting patent(s), including any reissue or reexamination thereof; and, any patents resulting from any provisional, non-provisional, refiling (including any refiling of a provisional or a non-provisional), continuation, continuation-in-part, division, renewal, or substitute, of any of the above-referenced patent applications, and as to any Letters Patent thereof, any reissue or reexamination thereof, and further covenants that the ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patents and legal equivalents as may be known and accessible to the ASSIGNOR and will testify as to the same in any proceeding in the U.S. Patent Office or any other Foreign Patent Office, or U.S. or foreign litigation or proceeding related thereto, and will promptly execute and deliver to the ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce, said patent applications, said inventions, said Letters Patents, and said equivalents thereof, which may be necessary or desirable to carry out the purposes thereof.

This Assignment is valid regardless of changes to employment status, mental status, or the creation of any licenses, written or oral, that relate to any of the above-referenced patent applications or the resulting patent(s). This Assignment fully and completely assigns all of the ASSIGNOR'S rights, title, and interest to the ASSIGNEE with regard to the above-referenced patent application, including, without limitation, any provisionals, non-provisionals, refilings (including refilings of provisionals or non-provisionals), continuations, continuations-in-part, divisions, renewals, or substitutes, relating to, or claiming priority from the above-referenced patent application, and resulting patent(s), including, without limitation, any reissues, reexaminations thereof; and the ASSIGNEE may freely and unilaterally assign the above-referenced patent application, or its resulting patent(s) without further consent from or compensation to the ASSIGNOR. No other agreement or document, written or oral, is effective in revoking this Assignment other than a specific amendment or revocation specifically referencing this Assignment and signed by all parties with authority to enter into such an agreement.

This Assignment may be executed and is valid in counterparts.

In witness whereof, I have hereunto set hand and seal and thereby make this Assignment executed, effective, complete and final on the date set forth below.

Executed for and on behalf of HYCON TECHNOLOGY CORPORATION

HYCON TECHNOLOGY CORPORATION

Date: 2027. 3. 6

Executed for and on behalf of Silicon Integrated Systems Corp.

Silicon Integrated Systems Corp.

Date: 2025, 3.6.